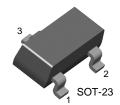


MMBT3904K

NPN Epitaxial Silicon Transistor

General Purpose Transistor





1. Base 2. Emitter 3. Collector

Absolute Maximum Ratings T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage	60	V
V _{CEO}	Collector-Emitter Voltage	40	V
V_{EBO}	Emitter-Base Voltage	6	V
I _C	Collector Current	200	mA
P _C	Collector Power Dissipation	350	mW
T _{STG}	Storage Temperature	150	°C

$\textbf{Electrical Characteristics} \ \, \textbf{T}_{a} \!\!=\!\! 25^{\circ} \text{C unless otherwise noted}$

Symbol	Parameter	Test Condition	Min.	Max.	Units
BV _{CBO}	Collector-Base Breakdown Voltage	$I_C = 10\mu A, I_E = 0$	60		V
BV _{CEO}	Collector-Emitter Breakdown Voltage *	$I_C = 1 \text{mA}, I_B = 0$	40		V
BV _{EBO}	Emitter-Base Breakdown Voltage	$I_E = 10\mu A, I_C = 0$	6		V
I _{CEX}	Collector Cut-off Current	V _{CE} = 30V, V _{EB} = 3V		50	nA
h _{FE}	DC Current Gain *	$V_{CE} = 1V, I_{C} = 0.1 \text{mA}$ $V_{CE} = 1V, I_{C} = 1 \text{mA}$ $V_{CE} = 1V, I_{C} = 10 \text{mA}$ $V_{CE} = 1V, I_{C} = 50 \text{mA}$ $V_{CE} = 1V, I_{C} = 100 \text{mA}$	40 70 100 60 30	300	
V _{CE} (sat)	Collector-Emitter Saturation Voltage *	$I_C = 10$ mA, $I_B = 1$ mA $I_C = 50$ mA, $I_B = 5$ mA		0.2 0.3	V V
V _{BE} (sat)	Base-Emitter Saturation Voltage *	$I_C = 10$ mA, $I_B = 1$ mA $I_C = 50$ mA, $I_B = 5$ mA	0.65	0.85 0.95	V V
C _{ob}	Output Capacitance	V _{CB} = 5V, I _E = 0, f = 1MHz		4	pF
f _T	Current Gain-Bandwidth Product	V _{CE} = 20V, I _C = 10mA, f = 100MHz	300		MHz
NF	Noise Figure	$I_C = 100\mu A, V_{CE} = 5V, R_S = 1K\Omega$ f = 10Hz to 15.7KHz		5	dB
t _{ON}	Turn On Time	$V_{CC} = 3V, V_{BE} = 0.5V$ $I_{C} = 10mA, I_{B1} = 1mA$		70	ns
t _{OFF}	Turn Off Time	$V_{CC} = 3V$, $I_C = 10mA$, $I_{B1} = I_{B2} = 1mA$		250	ns

^{*} Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%

Typical Performance Characteristics

Figure 1. DC current Gain

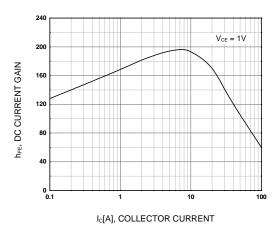
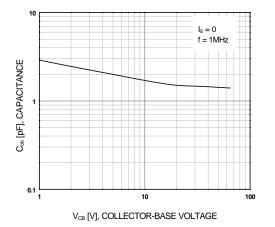


Figure 3. Output Capacitance



MMBT3904K Rev. A

Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

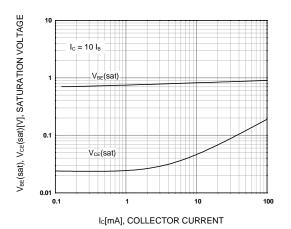
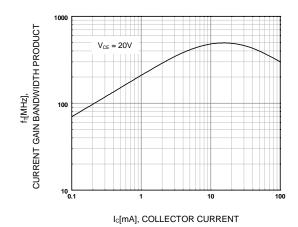


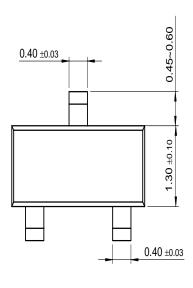
Figure 4. Current Gain Bandwidth Product

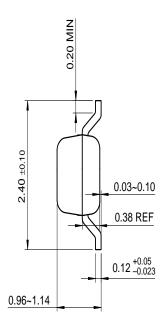


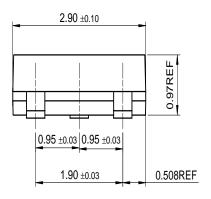
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Mechanical Dimensions

SOT-23







Dimensions in Millimeters

3

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